## DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION Attorney Docket No. 5649-1122

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

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the specification of wl	nich		•
is attached hereto	1		
OR	1		
was filed on	as United States	Application No. or PCT Int	ernational Application
Number and w	as amended on	(if applicable).	
<u>-</u>		nderstand the contents of the	
Title 37 Code of Fede available between the International filing da I hereby claim foreign § 365(b) of any foreign PCT International app	ral Regulations, §; filing date of the p te of the continuat a priority benefits u application(s) fo blication which des	mation which is material to 1.56, including material information and the Nation-in-part application, if apunder Title 35, United States are patent or inventor's certificinated at least one country a size identified below one	ormation that became tional or PCT oplicable.  s Code, § 119(a)-(d) or cate, or § 365(a) of any other than the United
States of America, list patent or inventor's celebrate that of the apple	rtificate, or of any	PCT International application	
patent or inventor's ce	rtificate, or of any	PCT International application	
patent or inventor's ce before that of the appl	ertificate, or of any lication on which p	PCT International applicationity is claimed.	ion having a filing date
patent or inventor's ce before that of the appl 2002-0035931	ertificate, or of any lication on which p Korea	PCT International applicationiority is claimed.  06/26/2002	ion having a filing date  ☑ Yes ☐ No

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below.

None	
Application Number(s)	Filing Date (MM/DD/YYYY)
Application Number(s)	Filing Date (MM/DD/YYYY)

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) or § 365(c) of any PCT international application designating the United States of America, listed below.

None Appin. Serial No.	Filing Date	Status
Appin. Serial No.	Filing Date	Patented/Pending/Abandoned  Status Patented/Pending/Abandoned
Appln. Serial No.	Filing Date	Status Patented/Pending/Abandoned

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following registered attorney(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. I also appoint the following registered attorney(s) to represent me before all competent International Authorities in connection with any and all international

applications filed by me with an appropriate receiving office claiming priority to the U.S. application. I also appoint the following registered attorney(s) to make or receive payment on my behalf in connection with the filing of such international applications.

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